

# Automotive P-Channel 60 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-60				
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = -10 V	0.0093				
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.0133				
I <sub>D</sub> (A)	-100				
Configuration	Single				

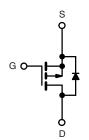


### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- Package with low thermal resistance
- AEC-Q101 qualified d
- 100 %  $R_g$  and UIS tested

RoHS COMPLIANT HALOGEN FREE

 Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>



P-Channel MOSFET

ORDERING INFORMATION	
Package	TO-220
Lead (Pb)-free and Halogen-free	SQP100P06-9m3L-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	-60	N	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current	T <sub>C</sub> = 25 °C	1-	-100		
	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	-58		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	-120	А	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	-300		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	-70		
Single Pulse Avalanche Energy		E <sub>AS</sub>	245	mJ	
	T <sub>C</sub> = 25 °C	PD	187	W	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 125 °C	۲D	62	~~~	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	40	°C/W	
Junction-to-Case (Drain)			0.8	C/W	

#### Notes

a. Package limited.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. When mounted on 1" square Pcb (Fr-4 material).

d. Parametric verification ongoing.

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# SQP100P06-9m3L



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	•							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = -250 \ \mu A$		-60	-	-	v	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D$ = -250 $\mu$ A	-1.5	-2.0	-2.5	v	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, $V_{GS}$ = ± 20 V	-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = -60 V	I	-	-1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS}$ = -60 V, $T_J$ = 125 °C	1	-	-50	μA	
		$V_{GS} = 0 V$	$V_{DS}$ = -60 V, $T_J$ = 175 °C	-	-	-250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = -10 V$	$V_{DS} \le -5 V$	-100	-	-	А	
		$V_{GS} = -10 V$	I <sub>D</sub> = -30 A	-	0.0072	0.0093	- Ω	
Drain-Source On-State Resistance <sup>a</sup>	Brach	$V_{GS} = -10 V$	$I_D$ = -30 A, $T_J$ = 125 °C	-	-	0.0151		
Drain-Source On-State Resistance ~	R <sub>DS(on)</sub>	$V_{GS} = -10 V$	$I_D$ = -30 A, $T_J$ = 175 °C	-	-	0.0184		
		$V_{GS} = -4.5 V$	I <sub>D</sub> = -20 A	-	0.0102	0.0133		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -30 A		-	82	-	S	
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>			-	9605	12 010		
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	$V_{DS}$ = -25 V, f = 1 MHz	-	1030	1290	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	750	940		
Total Gate Charge <sup>c</sup>	Qg			-	198	300		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V	$V_{DS} = -30 \text{ V}, \text{ I}_{D} = -100 \text{ A}$	-	30	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	54	-		
Gate Resistance	R <sub>g</sub>		f = 1 MHz		2.2	3.5	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	18	30		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}=-30~V,~R_L=0.3~\Omega$ $I_D\cong-100~A,~V_{GEN}=-10~V,~R_g=1~\Omega$		-	12	20	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	85	130		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	36	55		
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>							
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	-300	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = -80 A, V <sub>GS</sub> = 0			-0.95	-1.5	V	

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

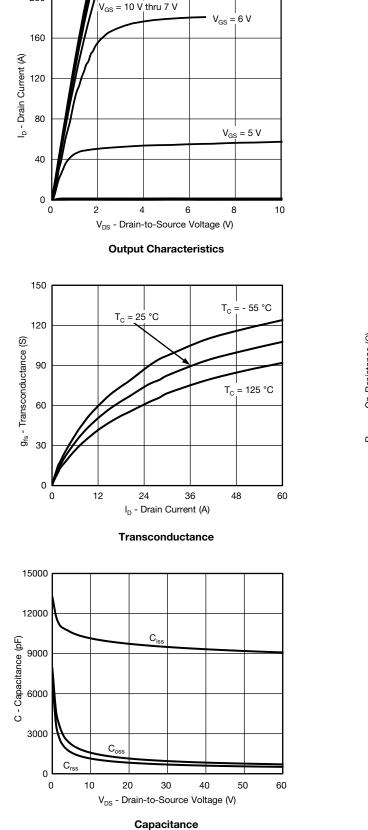
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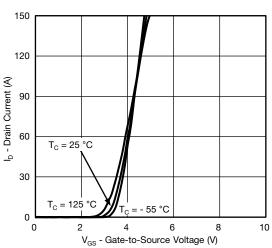


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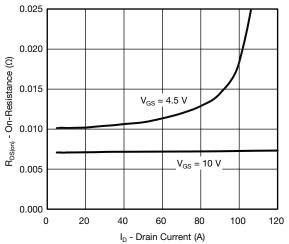
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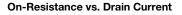
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)

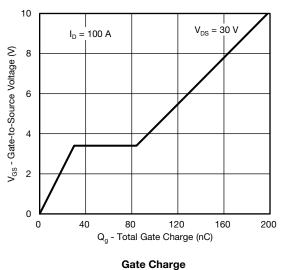












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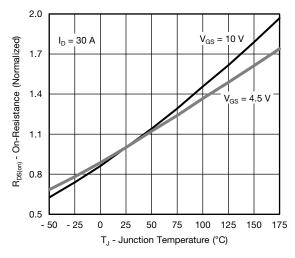
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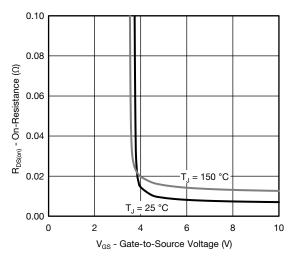
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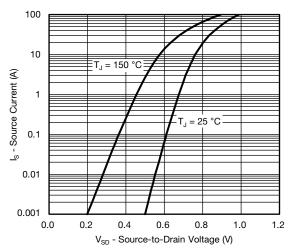
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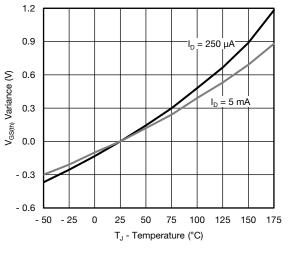
**On-Resistance vs. Junction Temperature** 



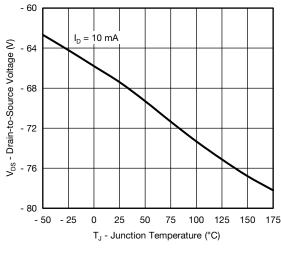
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage



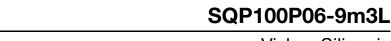
**Threshold Voltage** 



Drain Source Breakdown vs. Junction Temperature 4

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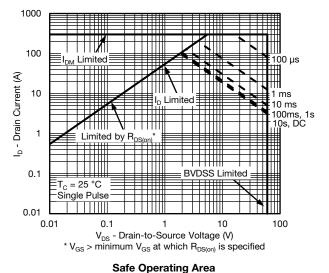
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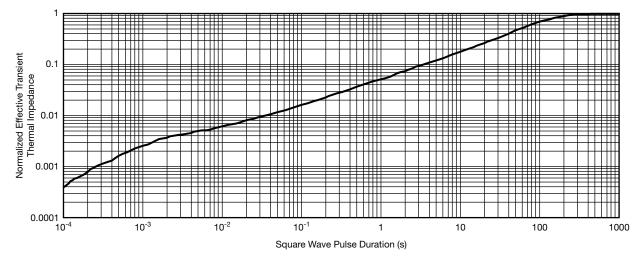


### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)

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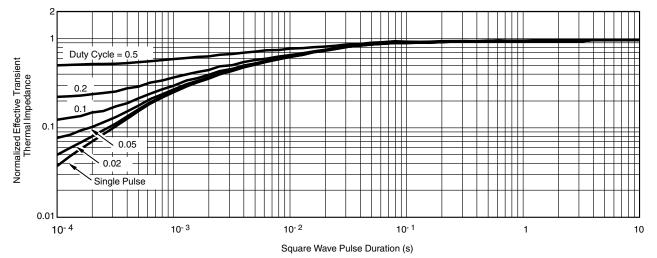




Normalized Thermal Transient Impedance, Junction-to-Ambient



### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

· The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

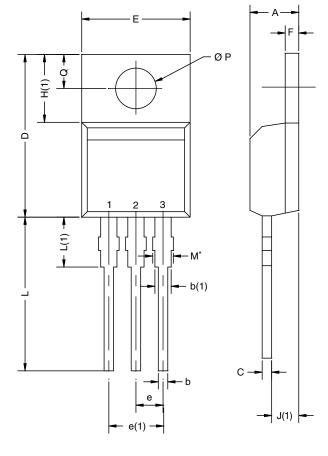
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?62971">www.vishay.com/ppg?62971</a>.



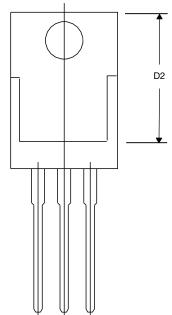
# **TO-220AB**



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
E	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
	0413-Rev. P,		0.102	0.118

Note

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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